Dorado Memory Extension Board
Stuffing and Configuration Instructions

1. Break h20.10 before stuffing.

   All SG10139 chips are PROMS which must be blown and labeled before stuffing.

   Stuff all PLAT1816 with Beckman type 898-3-R27 resistor packs or equivalent.

2. Do all the actions in one of the following two columns.

Action	64K Map Chips	256K Map Chips
Blue Wire	k4.5 to k4.16	k4.4 to k4.16
Stuff into MosRam sockets	TMS4156 or equivalent	256K Ram or equivalent
Jumper wires in socket b14	6 to 11 4 to 13 2 to 15	6 to 11 4 to 13 2 to 15
Jumper wires in socket c12	6 to 11 4 to 13 2 to 15	6 to 11 4 to 13 2 to 15
1 KOhm resistor in socket b14 and 1 KOhm resistor in socket c12	NO	NO
22 uf Cap in PLAT c11 & b13	+ 2 to 15 + 4 to 13	+ 2 to 15 + 4 to 13